

# **PCF8532**

# Universal LCD driver for low multiplex rates Rev. 1 — 10 February 2009

**Product data sheet** 

#### **General description** 1.

The PCF8532 is a peripheral device which interfaces to almost any Liquid Crystal Display (LCD) with low multiplex rates. It generates the drive signals for any static or multiplexed LCD containing up to four backplanes and up to 160 segments and can easily be cascaded for larger LCD applications. The PCF8532 is compatible with most microprocessors or microcontrollers and communicates via a two-line bidirectional I<sup>2</sup>C-bus. Communication overheads are minimized by a display RAM with auto-incremental addressing, by hardware subaddressing and by display memory switching (static and duplex drive modes).

#### 2. **Features**

- Single-chip LCD controller and driver for up to 640 elements
- Selectable backplane drive configuration: static or 2, 3 or 4 backplane multiplexing
- 160 segment drives:
  - Up to 80 7-segment numeric characters
  - ◆ Up to 42 14-segment alphanumeric characters
  - Any graphics of up to 640 elements
- May be cascaded for large LCD applications (up to 2560 elements possible)
- 160 × 4-bit RAM for display data storage
- Software programmable frame frequency in steps of 5 Hz in the range of 60 Hz to 90 Hz
- Wide LCD supply range: from 2.5 V for low threshold LCDs and up to 8.0 V for guest-host LCDs and high threshold (automobile) twisted nematic LCDs
- Internal LCD bias generation with voltage-follower buffers
- Selectable display bias configuration: static,  $\frac{1}{2}$  or  $\frac{1}{3}$
- Wide power supply range: from 1.8 V to 5.5 V
- LCD and logic supplies may be separated
- Low power consumption, typically:  $I_{DD} = 4 \mu A$ ,  $I_{DD(LCD)} = 40 \mu A$
- 400 kHz I<sup>2</sup>C-bus interface
- Auto-incremental display data loading across device subaddress boundaries
- Versatile blinking modes
- Compatible with Chip-On-Glass (COG) technology
- Display memory bank switching in static and duplex drive modes
- No external components
- Manufactured in silicon gate CMOS process
- Two sets of backplane outputs for optimal COG configurations of the application



#### Universal LCD driver for low multiplex rates

# 3. Ordering information

Table 1. Ordering information

| Type number    | Package  |   |          |  |  |  |
|----------------|----------|---|----------|--|--|--|
|                | Name     | Description   | Version  |  |  |  |
| PCF8532U/2DA/1 | PCF8532U | bare die; 197 bumps; $6.5 \times 1.16 \times 0.38 \text{ mm}^{[1]}$ | PCF8532U |  |  |  |

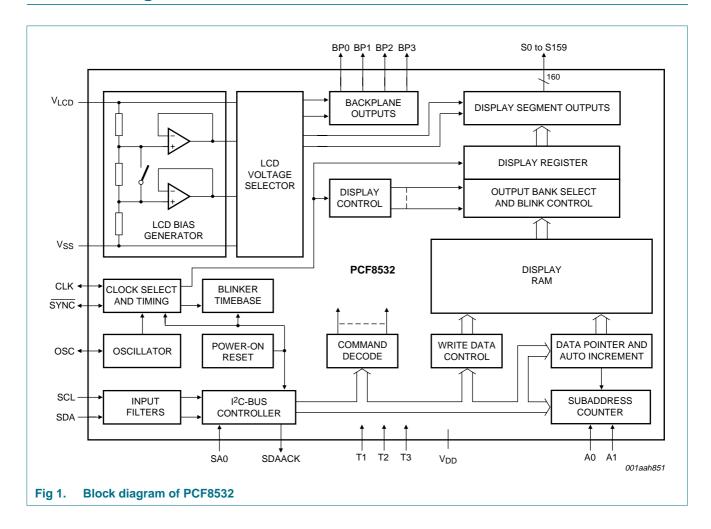
<sup>[1]</sup> Chip with bumps in tray.

# 4. Marking

Table 2. Marking codes

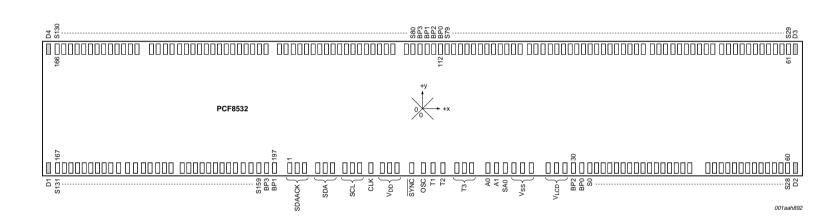
| Type number    | Marking code |
|----------------|--------------|
| PCF8532U/2DA/1 | PC8532-1     |

# 5. Block diagram



CF8532

# 6.1 Pinning



Top view. For mechanical details, see Figure 24.

Fig 2. Bonding pad location of PCF8532

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# 6.2 Pin description

Table 3. Pin description

| Symbol                | Pin                 |     | Description   |
|-----------------------|---------------------|-----|---|
| SDAACK                | 1 to 3              | [1] | I <sup>2</sup> C-bus acknowledge output                                   |
| SDA                   | 4 to 6              | [1] | I <sup>2</sup> C-bus serial data input                                    |
| SCL                   | 7 to 9              |     | I <sup>2</sup> C-bus serial clock input                                   |
| CLK                   | 10                  |     | clock input/output  |
| $V_{DD}$              | 11 to 13            |     | supply voltage  |
| SYNC                  | 14                  |     | cascade synchronization input/output                                      |
| OSC                   | 15                  |     | selection of internal or external clock                                   |
| T1, T2 and T3         | 16, 17 and 18 to 20 |     | dedicated testing pins; to be tied to V <sub>SS</sub> in application mode |
| A0 and A1             | 21, 22              |     | subaddress inputs   |
| SA0                   | 23                  |     | I <sup>2</sup> C-bus slave address input                                  |
| V <sub>SS</sub>       | 24 to 26            | [2] | logic ground  |
| $V_{LCD}$             | 27 to 29            |     | LCD supply voltage  |
| BP2 and BP0           | 30, 31              |     | LCD backplane outputs   |
| S0 to S79             | 32 to 111           |     | LCD segment outputs   |
| BP0, BP2, BP1 and BP3 | 112 to 115          |     | LCD backplane outputs   |
| S80 to S159           | 116 to 195          |     | LCD segment outputs   |
| BP3 and BP1           | 196, 197            |     | LCD backplane outputs   |

<sup>[1]</sup> In most applications SDA and SDAACK can be tied together.

# 7. Functional description

The PCF8532 is a versatile peripheral device designed to interface any microprocessor or microcontroller to a wide variety of LCDs. It can directly drive any static or multiplexed LCD containing up to four backplanes and up to 160 segments.

The display configurations possible with the PCF8532 depend on the number of active backplane outputs required. A selection of display configurations is shown in Table 4.

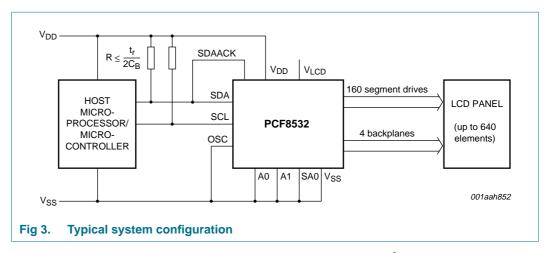
All of the display configurations can be implemented in a typical system as shown in Figure 3.

Table 4. Possible display configurations

| Number of  |          | 7-segment | ment numeric 14-segment numeric |            | numeric           | Dot matrix                |
|------------|----------|-----------|---------------------------------|------------|-------------------|---------------------------|
| Backplanes | Elements | Digits    | Indicator symbols               | Characters | Indicator symbols |                           |
| 4          | 640      | 80        | 80                              | 40         | 80                | 640 dots (4 × 160)        |
| 3          | 480      | 60        | 60                              | 32         | 32                | 480 dots (3 $\times$ 160) |
| 2          | 320      | 40        | 40                              | 20         | 40                | 320 dots (2 $\times$ 160) |
| 1          | 160      | 20        | 20                              | 10         | 20                | 160 dots (1 × 160)        |

<sup>[2]</sup> The substrate (rear side of the die) is wired to  $V_{SS}$  but should not be electrically connected.

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The host microprocessor or microcontroller maintains the 2-line I<sup>2</sup>C-bus communication channel with the PCF8532.

Biasing voltages for the multiplexed LCD waveforms are generated internally, removing the need for an external bias generator. The internal oscillator is selected by connecting pin OSC to  $V_{SS}$ . The only other connections required to complete the system are the power supplies ( $V_{DD}$ ,  $V_{SS}$  and  $V_{LCD}$ ) and the LCD panel selected for the application.

#### 7.1 Power-on reset

At power-on the PCF8532 resets to a default starting condition:

- All backplane and segment outputs are set to V<sub>LCD</sub>
- The selected drive mode is 1:4 multiplex with ½ bias
- · Blinking is switched off
- Input and output bank selectors are reset
- The I<sup>2</sup>C-bus interface is initialized
- The data pointer and the subaddress counter are cleared (set to logic 0)
- The display is disabled
- If internal oscillator is selected (OSC pin connected to V<sub>SS</sub>), then there is no clock signal on pin CLK

Do not transfer data on the  $I^2C$ -bus after a power-on for at least 1 ms to allow the reset action to complete.

# 7.2 LCD bias generator

Fractional LCD biasing voltages are obtained from an internal voltage divider of three series resistors connected between  $V_{LCD}$  and  $V_{SS}$ . The center resistor can be switched out of the circuit to provide a  $\frac{1}{2}$  bias voltage level for the 1:2 multiplex configuration.

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# 7.3 LCD voltage selector

The LCD voltage selector coordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by mode-set commands from the command decoder. The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of  $V_{LCD}$  and the resulting discrimination ratios (D), are given in Table 5.

| Table 5. | Preferred I | LCD drive | modes: | summary | of | characteristics |
|----------|-------------|-----------|--------|---------|----|-----------------|
|----------|-------------|-----------|--------|---------|----|-----------------|

| LCD drive mode | Number of: |             | LCD bias      | $V_{off(RMS)}$   | $V_{on(RMS)}$    | $D = \frac{V_{on(RMS)}}{V_{on(RMS)}}$ |  |
|----------------|------------|-------------|---------------|------------------|------------------|---------------------------------------|--|
|                | Backplanes | Bias levels | configuration | V <sub>LCD</sub> | V <sub>LCD</sub> | $D = \frac{on(RMS)}{V_{off}(RMS)}$    |  |
| static         | 1          | 2           | static        | 0                | 1                | ∞                                     |  |
| 1:2 multiplex  | 2          | 3           | 1/2           | 0.354            | 0.791            | 2.236                                 |  |
| 1:2 multiplex  | 2          | 4           | 1/3           | 0.333            | 0.745            | 2.236                                 |  |
| 1:3 multiplex  | 3          | 4           | 1/3           | 0.333            | 0.638            | 1.915                                 |  |
| 1:4 multiplex  | 4          | 4           | 1/3           | 0.333            | 0.577            | 1.732                                 |  |

A practical value for  $V_{LCD}$  is determined by equating  $V_{off(RMS)}$  with a defined LCD threshold voltage ( $V_{th}$ ), typically when the LCD exhibits approximately 10 % contrast. In the static drive mode a suitable choice is  $V_{LCD} > 3V_{th}$ .

Multiplex drive modes of 1:3 and 1:4 with  $\frac{1}{2}$  bias are possible but the discrimination and hence the contrast ratios are smaller.

Bias is calculated by  $\frac{1}{1+a}$ , where the values for a are

a = 1 for  $\frac{1}{2}$  bias

a = 2 for  $\frac{1}{3}$  bias

The RMS on-state voltage (Von(RMS)) for the LCD is calculated with the equation

$$V_{on(RMS)} = \sqrt[V_{LCD}]{\frac{1}{n} + \left[ (n-1) \times \left( \frac{1}{1+a} \right) \right]^2}$$
(1)

where V<sub>LCD</sub> is the resultant voltage at the LCD segment and where the values for n are

n = 1 for static mode

n = 2 for 1:2 multiplex

n = 3 for 1:3 multiplex

n = 4 for 1:4 multiplex

The RMS off-state voltage (V<sub>off(RMS)</sub>) for the LCD is calculated with the equation:

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a^2 - (2a + n)}{n \times (1 + a)^2}}$$
 (2)

Discrimination is the ratio of V<sub>on(RMS)</sub> to V<sub>off(RMS)</sub> and is determined from the equation:

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$$\frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{(a+1)^2 + (n-1)}{(a-1)^2 + (n-1)}}$$
(3)

Using Equation 3, the discrimination for an LCD drive mode of

- 1:3 multiplex with  $\frac{1}{2}$  bias is  $\sqrt{3} = 1.732$
- 1:4 multiplex with  $\frac{1}{2}$  bias is  $\frac{\sqrt{21}}{3} = 1.528$

The advantage of these LCD drive modes is a reduction of the LCD full scale voltage  $V_{\text{LCD}}$  as follows:

- 1:3 multiplex ( $\frac{1}{2}$  bias):  $V_{LCD} = \sqrt{6} \times V_{off(RMS)} = 2.449 V_{off(RMS)}$
- 1:4 multiplex (½ bias):  $V_{LCD} = \left\lceil \frac{(4 \times \sqrt{3})}{3} \right\rceil = 2.309 V_{off(RMS)}$

These compare with  $V_{LCD} = 3V_{off(RMS)}$  when  $\frac{1}{3}$  bias is used.

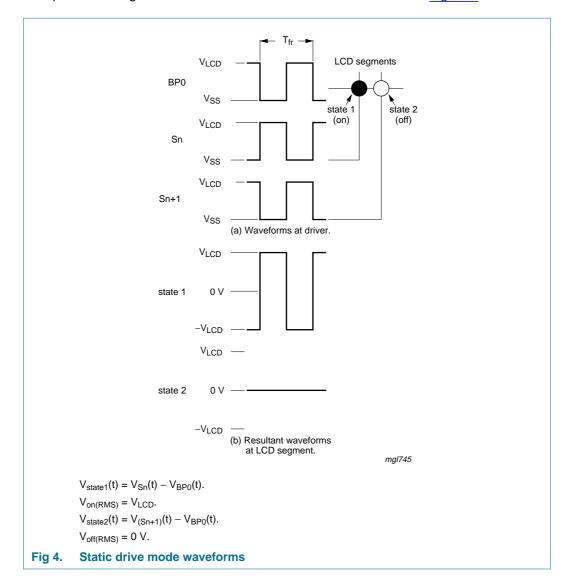
It should be noted that  $V_{\text{LCD}}$  is sometimes referred as the LCD operating voltage.

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# 7.4 LCD drive mode waveforms

# 7.4.1 Static drive mode

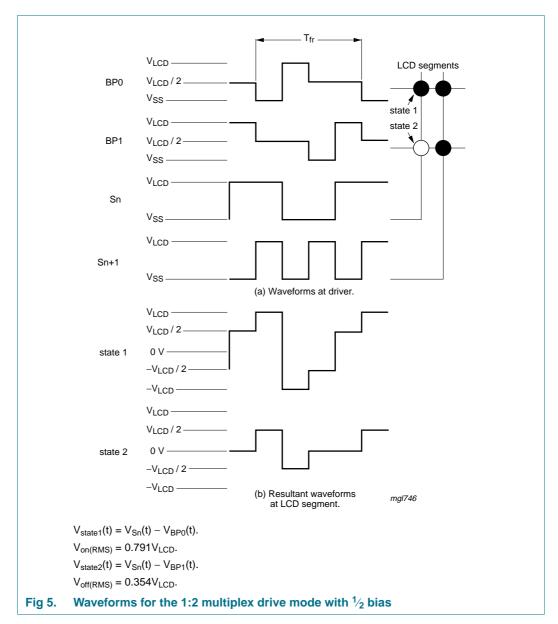
The static LCD drive mode is used when a single backplane is provided in the LCD. Backplane and segment drive waveforms for this mode are shown in Figure 4.



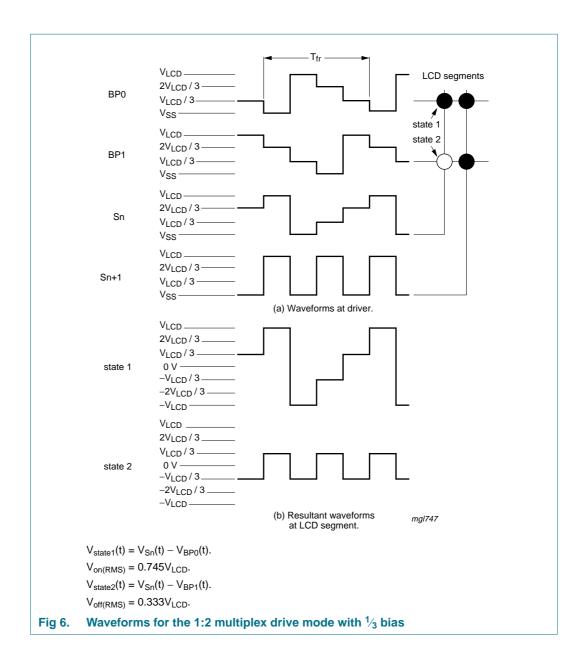
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# 7.4.2 1:2 multiplex drive mode

When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCF8532 allows the use of  $\frac{1}{2}$  bias or  $\frac{1}{3}$  bias in this mode as shown in Figure 5 and Figure 6.



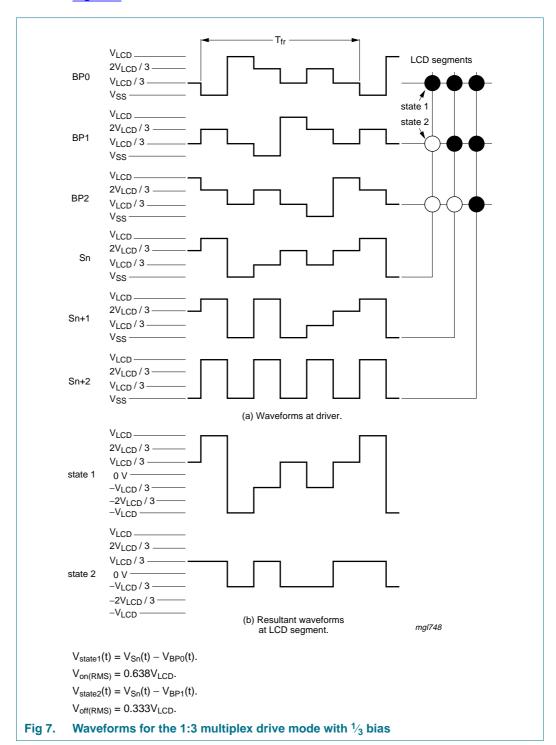
# Universal LCD driver for low multiplex rates



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# 7.4.3 1:3 multiplex drive mode

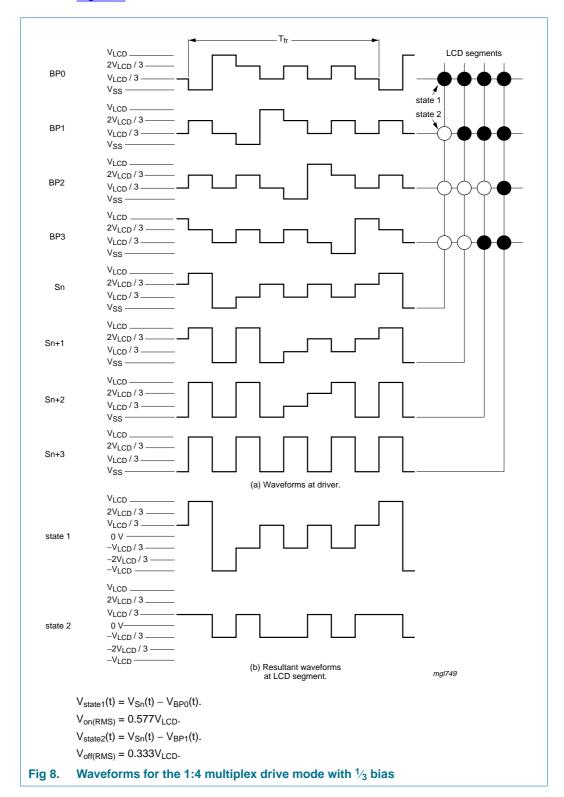
When three backplanes are provided in the LCD, the 1:3 multiplex drive mode applies as shown in Figure 7.



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# 7.4.4 1:4 multiplex drive mode

When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies as shown in Figure 8.



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#### 7.5 Oscillator

The internal logic and the LCD drive signals of the PCF8532 are timed by a frequency  $f_{clk}$  which either is derived from the built-in oscillator frequency  $f_{osc}$  ( $f_{clk} = \frac{f_{osc}}{64}$ ) or equals an external clock frequency  $f_{clk(ext)}$  ( $f_{clk} = f_{clk(ext)}$ ).

The clock frequency  $f_{clk}$  determines the LCD frame frequency  $f_{fr}$  (see Table 15).

#### 7.5.1 Internal clock

The internal logic and the LCD drive signals of the PCF8532 are timed either by the built-in oscillator or by an external clock.

The internal oscillator is enabled by connecting pin OSC to pin  $V_{SS}$ . In this case the output from pin CLK provides the clock signal for cascaded PCF8532's in the system. However, the clock signal is only available at the pin CLK, if the display is enabled. The display is enabled using the display enable bit (see Table 9).

The nominal output clock frequency is like specified in Table 18 with parameter f<sub>clk</sub>.

#### 7.5.2 External clock

Connecting pin OSC to  $V_{DD}$  enables an external clock source. Pin CLK then becomes the external clock input.

A clock signal must always be supplied to the device; removing the clock may freeze the LCD in a DC state.

#### 7.6 Timing and frame frequency

The timing of the PCF8532 organizes the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. In cascaded applications, the synchronization signal (SYNC) maintains the correct timing relationship between all the PCF8532's in the system.

The clock frequency can be programmed by software such that the nominal frame frequency can be chosen in steps of 5 Hz in the range of 60 Hz to 90 Hz (see Table 15).

# 7.7 Display register

The display register holds the display data while the corresponding multiplex signals are generated. There is a one-to-one relationship between the data in the display register, the LCD segment outputs and one column of the display RAM.

#### 7.8 Segment outputs

The LCD drive section includes 160 segment outputs (S0 to S159) which must be connected directly to the LCD. The segment output signals are generated in accordance with the multiplexed backplane signals and with data residing in the display register. When less than 160 segment outputs are required the unused segment outputs must be left open-circuit.

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#### 7.9 Backplane outputs

The LCD drive section includes four backplane outputs: BP0 to BP3. The backplane output signals are generated in accordance with the selected LCD drive mode.

In the 1:4 multiplex drive mode BP0 to BP3 must be connected directly to the LCD.

If less than four backplane outputs are required the unused outputs can be left open-circuit.

- In 1:3 multiplex drive mode BP3 carries the same signal as BP1, therefore these two adjacent outputs can be tied together to give enhanced drive capabilities.
- In 1:2 multiplex drive mode BP0 and BP2, BP1 and BP3 respectively carry the same signals and may also be paired to increase the drive capabilities.
- In static drive mode the same signal is carried by all four backplane outputs and they can be connected in parallel for very high drive requirements.

The pins for the four backplanes BP0 to BP3 are available on both pin bars of the chip. In applications it is possible to use either the pins for the backplanes

- on the top pin bar
- on the bottom pin bar
- or both of them to increase the driving strength of the device.

When using all backplanes available they may be connected to the respective sibling (BP0 on the top pin bar with BP0 on the bottom pin bar and so on).

# 7.10 Display RAM

The display RAM is a static  $160 \times 4$ -bit RAM which stores LCD data. A logic 1 in the RAM bit map indicates the on-state of the corresponding LCD element (it is shaded); similarly, a logic 0 indicates the off-state (it is translucent). There is a one-to-one correspondence between the RAM addresses and the segment outputs and between the individual bits of a RAM word and the backplane outputs. The first RAM row corresponds to the 160 elements operated with respect to backplane BP0 (see Figure 9). In multiplexed LCD applications the segment data of the first, second, third and fourth row of the display RAM are time-multiplexed with BP0, BP1, BP2 and BP3 respectively.

When display data is transmitted to the PCF8532 the display bytes received are stored in the display RAM in accordance with the selected LCD drive mode. The data is stored as it arrives and does not wait for the acknowledge cycle as with the commands. Depending on the current multiplex mode data is stored singularly, in pairs, triplets or quadruplets, e.g. in 1:2 multiplex mode the RAM data is stored every second bit. To illustrate the filling order, an example of a 7-segment numeric display showing all drive modes is given in Figure 10; the RAM filling organization depicted applies equally to other LCD types.

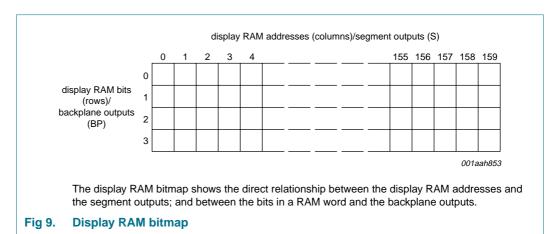
The following applies to Figure 10:

- In static drive mode the eight transmitted data bits are placed in row 0 to eight successive display RAM addresses.
- In 1:2 multiplex mode the eight transmitted data bits are placed in row 0 and 1 to four successive display RAM addresses.

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In 1:3 multiplex mode the bits are placed in row 0, 1 and 2 to three successive
addresses, with bit 2 of the third address left unchanged. This last bit may, if
necessary, be controlled by an additional transfer to this address but care should be
taken to avoid overwriting adjacent data because always full bytes are transmitted.

• In the 1:4 multiplex mode the eight transmitted data bits are placed in row 0, 1, 2 and 3 to two successive display RAM addresses.



# 7.11 Data pointer

The addressing mechanism for the display RAM is realized using the data pointer.

This allows the loading of an individual display data byte, or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialization of the data pointer by the load-data-pointer-MSB and load-data-pointer-LSB commands.

Following this two commands, an arriving data byte is stored starting at the display RAM address indicated by the data pointer. The filling order is shown in Figure 10.

The data pointer is automatically incremented in accordance with the chosen LCD configuration.

The contents of the data pointer are incremented as follows:

- In static drive mode by eight
- In 1:2 multiplex drive mode by four
- In 1:3 multiplex drive mode by three
- In 1:4 multiplex drive mode by two

If the data pointer reaches 159 it is automatically wrapped around to address 0, consequently the subaddress counter is incremented.

If an I<sup>2</sup>C-bus data access is terminated early then the state of the data pointer is unknown. The data pointer must be re-written prior to further RAM accesses.

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| drive mode       | LCD segments  | LCD backplanes | display RAM filling order  | transmitted display byte |
|------------------|---|----------------|--|--------------------------|
| static           | $S_{n+2}$ $=$ $a$ $b$ $S_{n+1}$ $S_{n+4}$ $=$ $g$ $=$ $S_{n+5}$ $=$ $g$ $=$ $=$ $g$ $=$ $g$ $=$ $g$ $=$ $=$ $g$ $=$ $=$ $g$ $=$ $=$ $g$ $=$ $=$ $=$ $=$ $=$ $=$ $=$ $=$ $=$ $=$ | вро            | n         n+1         n+2         n+3         n+4         n+5         n+6         n+7           bit/ 0         c         b         a         f         g         e         d         DP           BP 1         x         x         x         x         x         x         x         x           2         x         x         x         x         x         x         x         x           3         x         x         x         x         x         x         x         x | MSB LSB                  |
| 1:2<br>multiplex | $S_{n-1}$ $S_{n+1}$ $S_{n+2}$ $S_{n+3}$ $DP$  | BP0 BP1        | n n+1 n+2 n+3  bit/ 0 a f e d BP 1 b g c DP 2 x x x x x x 3 x x x x x  | MSB LSB                  |
| 1:3<br>multiplex | S <sub>n+1</sub> a b S <sub>n</sub>   | BP0 BP1 BP2    | n   n+1   n+2  | MSB LSB                  |
| 1:4<br>multiplex | S <sub>n</sub> a b g c c DP   | BP1 BP3        | n n+1  bit/ 0 a f BP 1 c e 2 b g 3 DP d  | MSB LSB                  |

001aag281

x = data bit unchanged

Fig 10. Relationships between LCD layout, drive mode, display RAM filling order and display data transmitted over the I<sup>2</sup>C-bus

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# 7.12 Subaddress counter

The storage of display data is conditioned by the contents of the subaddress counter. Storage is allowed only when the content of the subaddress counter agree with the hardware subaddress applied to A0 and A1. The subaddress counter value is defined by the device-select command. If the content of the subaddress counter and the hardware subaddress do not match then data storage is inhibited but the data pointer is incremented as if data storage had taken place. The subaddress counter is also incremented when the data pointer overflows.

The storage arrangements described lead to extremely efficient data loading in cascaded applications. When a series of display bytes are sent to the display RAM, automatic wrap-over to the next PCF8532 occurs when the last RAM address is exceeded. Subaddressing across device boundaries is successful even if the change to the next device in the cascade occurs within a transmitted character (such as during the 54th display data byte transmitted in 1:3 multiplex mode).

The hardware subaddress must not be changed whilst the device is being accessed on the I<sup>2</sup>C-bus interface.

# 7.13 Output bank selector

The output bank selector selects one of the four bits per display RAM address for transfer to the display register. The actual bit selected depends on the LCD drive mode in operation and on the instant in the multiplex sequence.

- In 1:4 multiplex mode, all RAM addresses of bit 0 are selected, these are followed by the contents of bit 1, bit 2 and then bit 3
- In 1:3 multiplex mode, bits 0, 1 and 2 are selected sequentially
- In 1:2 multiplex mode, bits 0 and 1 are selected
- In the static mode, bit 0 is selected.

The SYNC signal will reset these sequences to the following starting points:

- Bit 3 for 1:4 multiplex mode
- Bit 2 for 1:3 multiplex mode
- Bit 1 for 1:2 multiplex mode
- · Bit 0 for static mode

The PCF8532 includes a RAM bank switching feature in the static and 1:2 multiplex drive modes. In the static drive mode, the bank-select command may request the contents of bit 2 to be selected for display instead of the contents of bit 0. In the 1:2 multiplex drive mode, the contents of bits 2 and 3 may be selected instead of bits 0 and 1. This gives the provision for preparing display information in an alternative bank and to be able to switch to it once it is assembled.

#### 7.14 Input bank selector

The input bank selector loads display data into the display RAM in accordance with the selected LCD drive configuration. Display data can be loaded in bit 2 in static drive mode or in bits 2 and 3 in 1:2 multiplex drive mode by using the bank-select command. The input bank selector functions independently to the output bank selector.

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#### 7.15 Blinker

The display blinking capabilities of the PCF8532 are very versatile. The whole display can blink at frequencies selected by the blink-select command. The blink frequencies are fractions of the clock frequency. The ratios between the clock and blink frequencies depend on the blink mode in which the device is operating, see Table 6.

**Table 6.** Blink frequencies Assuming that  $f_{clk} = 1.800 \text{ kHz}$ .

| Blink mode | Operating mode ratio               | Blink frequency |
|------------|------------------------------------|-----------------|
| off        | -                                  | blinking off    |
| 1          | $f_{blink} = \frac{f_{clk}}{768}$  | ~2.34 Hz        |
| 2          | $f_{blink} = \frac{f_{clk}}{1536}$ | ~1.17 Hz        |
| 3          | $f_{blink} = \frac{f_{clk}}{3072}$ | ~0.59 Hz        |

An additional feature is for an arbitrary selection of LCD segments to blink. This applies to the static and 1:2 multiplex drive modes and can be implemented without any communication overheads. By means of the output bank selector, the displayed RAM banks are exchanged with alternate RAM banks at the blink frequency. This mode can also be specified by the blink-select command.

In the 1:3 and 1:4 multiplex modes, where no alternate RAM bank is available, groups of LCD segments can blink selectively by changing the display RAM data at fixed time intervals.

If the entire display can blink at a frequency other than the nominal blink frequency. This can be effectively performed by resetting and setting the display enable bit E at the required rate using the mode-set command (see <u>Table 6</u>).

#### 7.16 Characteristics of the I<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial Clock Line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

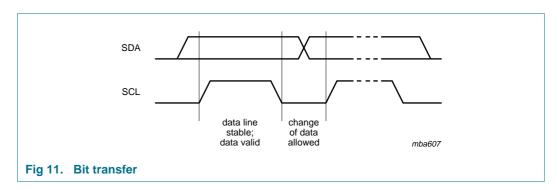
By connecting pin SDAACK to pin SDA on the PCF8532, the SDA line becomes fully I²C-bus compatible. Having the acknowledge output separated from the serial data line is advantageous in Chip-On-Glass (COG) applications. In COG applications where the track resistance from the SDAACK pin to the system SDA line can be significant, a potential divider is generated by the bus pull-up resistor and the Indium Tin Oxide (ITO) track resistance. It is possible that during the acknowledge cycle the PCF8532 will not be able to create a valid logic 0 level. By splitting the SDA input from the output the device could be used in a mode that ignores the acknowledge bit. In COG applications where the acknowledge cycle is required, it is necessary to minimize the track resistance from the SDAACK pin to the system SDA line to guarantee a valid LOW level.

The following definition assumes SDA and SDAACK are connected and refers to the pair as SDA.

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#### 7.16.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal. Bit transfer is shown in Figure 11.



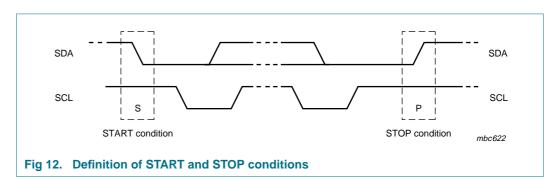
#### 7.16.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.

A HIGH-to-LOW change of the data line, while the clock is HIGH is defined as the START condition (S).

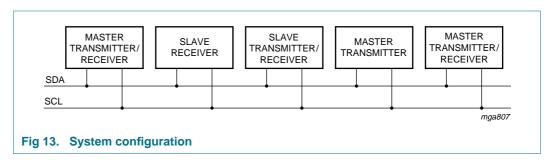
A LOW-to-HIGH change of the data line while the clock is HIGH is defined as the STOP condition (P).

The START and STOP conditions are shown in Figure 12.



# 7.16.3 System configuration

A device generating a message is a transmitter, a device receiving a message is the receiver. The device that controls the message is the master and the devices which are controlled by the master are the slaves. The system configuration is shown in Figure 13.



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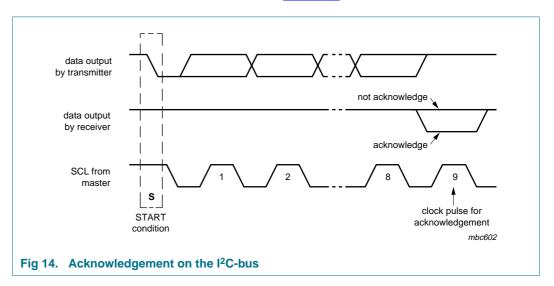
#### Universal LCD driver for low multiplex rates

#### 7.16.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse.

- A slave receiver which is addressed must generate an acknowledge after the reception of each byte.
- Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).
- A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

Acknowledgement on the I<sup>2</sup>C-bus is shown in Figure 14.



# 7.16.5 I<sup>2</sup>C-bus controller

The PCF8532 acts as an  $I^2C$ -bus slave receiver. It does not initiate  $I^2C$ -bus transfers or transmit data to an  $I^2C$ -bus master receiver. The only data output from the PCF8532 are the acknowledge signals of the selected devices. Device selection depends on the  $I^2C$ -bus slave address, on the transferred command data and on the hardware subaddress.

In single device application, the hardware subaddress inputs A0 and A1 are normally tied to  $V_{SS}$  which defines the hardware subaddress 0. In multiple device applications A0 and A1 are tied to  $V_{SS}$  or  $V_{DD}$  in accordance with a binary coding scheme such that no two devices with a common  $I^2C$ -bus slave address have the same hardware subaddress.

#### Universal LCD driver for low multiplex rates

#### 7.16.6 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

### 7.16.7 I<sup>2</sup>C-bus protocol

Two I<sup>2</sup>C-bus slave addresses (0111 000 and 0111 001) are reserved for the PCF8532. The least significant bit of the slave address that a PCF8532 responds to is defined by the level tied at its input SA0. The PCF8532 is a write only device and does not respond to a read access. Two types of PCF8532 can be distinguished on the same I<sup>2</sup>C-bus which allows:

- Up to 8 PCF8532's on the same I<sup>2</sup>C-bus for very large LCD applications
- The use of two types of LCD multiplex on the same I<sup>2</sup>C-bus.

The I<sup>2</sup>C-bus protocol is shown in <u>Figure 15</u>. The sequence is initiated with a START condition (S) from the I<sup>2</sup>C-bus master which is followed by one of the two PCF8532 slave addresses available. All PCF8532's with the corresponding SA0 level acknowledge in parallel to the slave address, but all PCF8532's with the alternative SA0 level ignore the whole I<sup>2</sup>C-bus transfer.

After acknowledgement, a control byte follows which defines if the next byte is RAM or command information. The control byte also defines if the next following byte is a control byte or further RAM/command data.

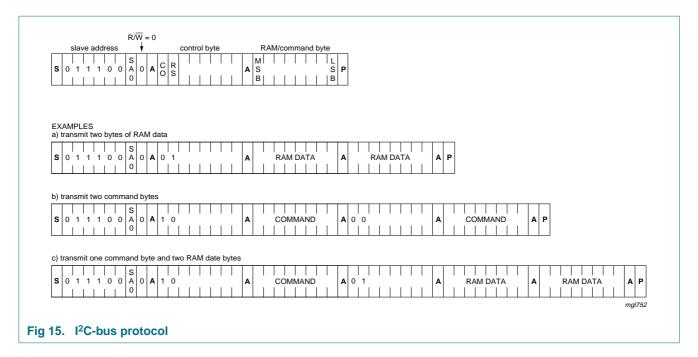
In this way it is possible to configure the device then fill the display RAM with little overhead.

The command bytes and control bytes are also acknowledged by all addressed PCF8532's connected to the bus.

The display bytes are stored in the display RAM at the address specified by the data pointer and the subaddress counter. Both data pointer and subaddress counter are automatically updated and the data is directed to the intended PCF8532 device.

The acknowledgement after each byte is made only by the (A0 and A1) addressed PCF8532. After the last (display) byte, the I<sup>2</sup>C-bus master issues a STOP condition (P). Alternatively a START may be issued to RESTART an I<sup>2</sup>C-bus access.

## Universal LCD driver for low multiplex rates



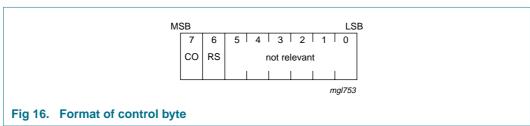


Table 7. Load-data-pointer command bit description

| Bit    | Symbol | Value | Description            |
|--------|--------|-------|------------------------|
| 7      | CO     |       | continue bit           |
|        |        | 0     | last control byte      |
|        |        | 1     | control bytes continue |
| 6      | RS     |       | register selection     |
|        |        | 0     | command register       |
|        |        | 1     | data register          |
| 5 to 0 | -      |       | not relevant           |

#### 7.17 Command decoder

The command decoder identifies command bytes that arrive on the I<sup>2</sup>C-bus. The commands available to the PCF8532 are defined in Table 8.

## Universal LCD driver for low multiplex rates

Table 8. Definition of PCF8532 commands

| Command               | Ope | Operation code |   |   |    | Reference |     |     |          |
|-----------------------|-----|----------------|---|---|----|-----------|-----|-----|----------|
| Bit                   | 7   | 6              | 5 | 4 | 3  | 2         | 1   | 0   |          |
| mode-set              | 1   | 1              | 0 | 0 | Е  | В         | M1  | MO  | Table 9  |
| load-data-pointer-MSB | 0   | 0              | 0 | 0 | P7 | P6        | P5  | P4  | Table 10 |
| load-data-pointer-LSB | 0   | 1              | 0 | 0 | P3 | P2        | P1  | P0  | Table 11 |
| device-select         | 1   | 1              | 1 | 0 | 0  | 0         | A1  | A0  | Table 12 |
| bank-select           | 1   | 1              | 1 | 1 | 1  | 0         | I   | 0   | Table 13 |
| blink-select          | 1   | 1              | 1 | 1 | 0  | Α         | BF1 | BF0 | Table 14 |
| frequency-prescaler   | 1   | 1              | 1 | 0 | 1  | F2        | F1  | F0  | Table 15 |

Table 9. Mode-set command bits description

| Bit    | Symbol | Value              | Description                       |
|--------|--------|--------------------|-----------------------------------|
| 7 to 4 | -      | 1100               | fixed value                       |
| 3      | Е      |                    | display status                    |
|        |        | 0[1]               | disabled (blank)[2]               |
|        |        | 1                  | enabled                           |
| 2 B    |        |                    | LCD bias configuration            |
|        | 0[1]   | $\frac{1}{3}$ bias |                                   |
|        |        | 1                  | $^{1}\!\!/_{\!2}$ bias            |
| 1 to 0 | M[1:0] |                    | LCD drive mode selection          |
|        |        | 01                 | static; BP0                       |
|        |        | 10                 | 1:2 multiplex; BP0, BP1           |
|        |        | 11                 | 1:3 multiplex; BP0, BP1, BP2      |
|        |        | 00[1]              | 1:4 multiplex; BP0, BP1, BP2, BP3 |

<sup>[1]</sup> Power-on and reset value.

Table 10. Load-data-pointer-MSB command bits description

| Bit    | Symbol | Value              | Description  |
|--------|--------|--------------------|--|
| 7 to 4 | -      | 0000               | fixed value  |
| 3 to 0 | P[7:4] | 0000[1] to<br>1001 | P7 to P4 defines the first 4 (most significant) bits of the data pointer that indicates one of the 160 display RAM addresses |

<sup>[1]</sup> Power-on and reset value.

Table 11. Load-data-pointer-LSB command bits description

| Bit    | Symbol | Value                      | Description  |
|--------|--------|----------------------------|--|
| 7 to 4 | -      | 0100                       | fixed value  |
| 3 to 0 | P[3:0] | 0000[ <u>1]</u> to<br>1111 | P3 to P0 defines the last 4 (least significant) bits of the data pointer that indicates one of the 160 display RAM addresses |

<sup>[1]</sup> Power-on and reset value.

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<sup>[2]</sup> The possibility to disable the display allows implementation of blinking under external control; the enable bit determines also wether the internal clock signal is available at the CLK pin (see Section 7.5.1).

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Table 12. Device-select command bits description

| Bit    | Symbol | Value                         | Description  |
|--------|--------|-------------------------------|--|
| 7 to 2 | -      | 111000                        | fixed value  |
| 1 to 0 | A[1:0] | 00 <u><sup>11</sup></u> to 11 | two bits of immediate data, bits A0 to A1, are transferred to the subaddress counter to define one of four hardware subaddresses |

<sup>[1]</sup> Power-on and reset value.

Table 13. Bank-select command bits description

| Bit    | Symbol | Value  | Description  |                        |  |  |
|--------|--------|--------|--|------------------------|--|--|
|        |        |        | Static   | 1:2 multiplex[1]       |  |  |
| 7 to 2 | -      | 111110 | fixed value  |                        |  |  |
| 1      | I      |        | input bank selection; storage of arriving display data |                        |  |  |
|        |        | 0[2]   | RAM bit 0  | RAM bits 0 and 1       |  |  |
|        |        | 1      | RAM bit 2  | RAM bits 2 and 3       |  |  |
| 0      | 0      |        | output bank selection; retriev                         | al of LCD display data |  |  |
|        |        | 0[2]   | RAM bit 0  | RAM bits 0 and 1       |  |  |
|        |        | 1      | RAM bit 2  | RAM bits 2 and 3       |  |  |

<sup>[1]</sup> The bank-select command has no effect in 1:3 and 1:4 multiplex drive modes.

Table 14. Blink-select command bits description

| Bit    | Symbol  | Value | Description                    |
|--------|---------|-------|--------------------------------|
| 7 to 3 | -       | 11110 | fixed value                    |
| 2 A    |         |       | blink mode selection           |
|        |         | 0[1]  | normal blinking[2]             |
|        |         | 1     | alternate RAM bank blinking[3] |
| 1 to 0 | BF[1:0] |       | blink frequency selection      |
|        |         | 00[1] | off                            |
|        |         | 01    | 1                              |
|        |         | 10    | 2                              |
|        |         | 11    | 3                              |
|        |         |       |                                |

<sup>[1]</sup> Power-on and reset value.

<sup>[2]</sup> Power-on and reset value.

<sup>[2]</sup> Normal blinking is assumed when the LCD multiplex drive modes 1:3 or 1:4 are selected.

<sup>[3]</sup> Alternating RAM bank blinking does not apply in 1:3 and 1:4 multiplex drive modes.

## Universal LCD driver for low multiplex rates

Table 15. Frame-frequency prescaler

|        |        | derency brock |                                     |  |  |
|--------|--------|---------------|-------------------------------------|--|--|
| Bit    | Symbol | Value         | Description                         |  |  |
|        |        |               | Nominal frame frequency 11          | Equation   |  |
| 7 to 4 | -      | 11101         | fixed value                         |  |  |
| 3 to 0 | F[2:0] |               | defines the division factor for the | ne frame frequency                                 |  |
|        |        | 000           | 60 Hz                               | $f_{fr} = \frac{64}{80} \times \frac{f_{clk}}{24}$ |  |
|        |        | 001           | 65 Hz                               | $f_{fr} = \frac{64}{74} \times \frac{f_{clk}}{24}$ |  |
|        |        | 010           | 70 Hz                               | $f_{fr} = \frac{64}{68} \times \frac{f_{clk}}{24}$ |  |
|        |        | 011[2]        | 75 Hz                               | $f_{fr} = \frac{f_{clk}}{24}$                      |  |
|        |        | 100           | 80 Hz                               | $f_{fr} = \frac{64}{60} \times \frac{f_{clk}}{24}$ |  |
|        |        | 101           | 85 Hz                               | $f_{fr} = \frac{64}{56} \times \frac{f_{clk}}{24}$ |  |
|        |        | 110           | 90 Hz                               | $f_{fr} = \frac{64}{53} \times \frac{f_{clk}}{24}$ |  |
|        |        | 111           | 75 Hz                               | $f_{fr} = \frac{f_{clk}}{24}$                      |  |

<sup>[1]</sup> Nominal frame frequency calculated for an internal operating frequency of 1.800 kHz.

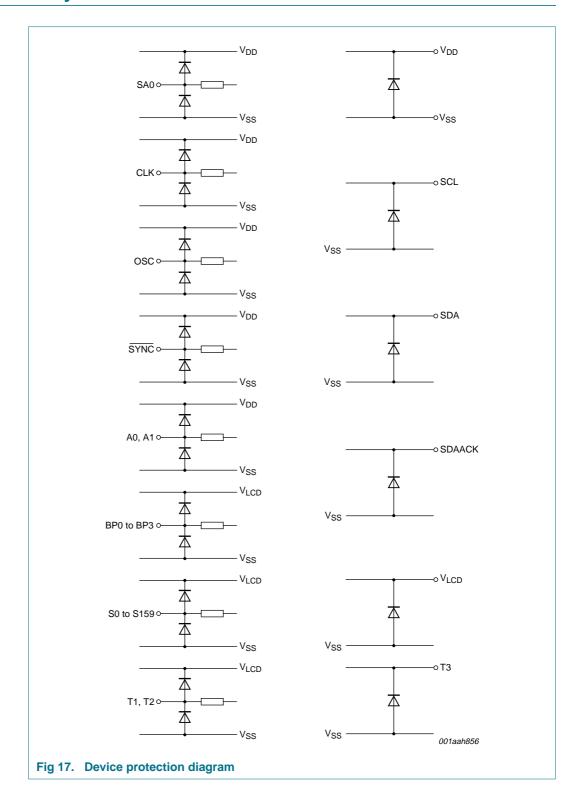
# 7.18 Display controller

The display controller executes the commands identified by the command decoder. It contains the status registers of the PCF8532 and co-ordinates their effects. The display controller is also responsible for loading display data into the display RAM as required by the filling order.

<sup>[2]</sup> Power-on and reset value.

# Universal LCD driver for low multiplex rates

# 8. Internal circuitry



## Universal LCD driver for low multiplex rates

# 9. Limiting values

#### **CAUTION**



Static voltages across the liquid crystal display can build up when the LCD supply voltage  $(V_{LCD})$  is on while the IC supply voltage  $(V_{DD})$  is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.

Table 16. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

| Symbol               | Parameter                       | Conditions   | Min               | Max   | Unit |
|----------------------|---------------------------------|--|-------------------|-------|------|
| $V_{DD}$             | supply voltage                  |  | -0.5              | +6.5  | V    |
| $I_{DD}$             | supply current                  |  | -50               | +50   | mA   |
| $V_{LCD}$            | LCD supply voltage              |  | -0.5              | +9.0  | V    |
| $I_{\text{DD(LCD)}}$ | LCD supply current              |  | -50               | +50   | mA   |
| VI                   | input voltage                   | on pins CLK, SYNC,<br>SA0, OSC, SDA, SCL<br>and A0, A1, T1, T2, T3 | -0.5              | +6.5  | V    |
| I <sub>I</sub>       | input current                   |  | -10               | +10   | mA   |
| Vo                   | output voltage                  | on pins S0 to S159 and BP0 to BP3                                  | -0.5              | +7.5  | V    |
|                      |                                 | on pins SDAACK,<br>CLK, SYNC                                       | -0.5              | +6.5  | V    |
| I <sub>O</sub>       | output current                  |  | -10               | +10   | mA   |
| I <sub>SS</sub>      | ground supply current           |  | -50               | +50   | mA   |
| P <sub>tot</sub>     | total power dissipation         |  | -                 | 400   | mW   |
| P/out                | power dissipation per output    |  | -                 | 100   | mW   |
| T <sub>stg</sub>     | storage temperature             | <u>[</u>   | <del>2]</del> –65 | +150  | °C   |
| V <sub>esd</sub>     | electrostatic discharge voltage | HBM [  | 3] _              | ±4500 | V    |
|                      |                                 | MM <u>E</u>  | 4] _              | ±250  | V    |
| I <sub>lu</sub>      | latch-up current                | [  | 5] _              | 200   | mA   |

<sup>[1]</sup> Stresses above these values listed may cause permanent damage to the device.

<sup>[2]</sup> According to the NXP store and transport conditions (document *SNW-SQ-623*) the devices have to be stored at a temperature of +5 °C to +45 °C and a humidity of 25 % to 75 %.

<sup>[3]</sup> Pass level; Human Body Model (HBM) according to JESD22-A114.

<sup>[4]</sup> Pass level; Machine Model (MM), according to JESD22-A115.

<sup>[5]</sup> Pass level; Latch-up testing, according to JESD78.

# Universal LCD driver for low multiplex rates

# 10. Static characteristics

Table 17. Static characteristics

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 8.0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

| Symbol               | Parameter                 | Conditions   |            | Min         | Тур | Max                      | Unit |
|----------------------|---------------------------|--|------------|-------------|-----|--------------------------|------|
| Supplies             | S                         |  |            |             |     |                          |      |
| $V_{DD}$             | supply voltage            |  |            | 1.8         | -   | 5.5                      | V    |
| $V_{LCD}$            | LCD supply voltage        |  |            | 1.8         | -   | 8.0                      | V    |
| I <sub>DD</sub>      | supply current            | $f_{clk(ext)} = 1.800 \text{ kHz}$   | [1][2<br>] | -           | 4   | 20                       | μΑ   |
|                      |                           | with internal oscillator running   | <u>[1]</u> | -           | 18  | 60                       | μΑ   |
| I <sub>DD(LCD)</sub> | LCD supply current        | $f_{clk(ext)} = 1.800 \text{ kHz}$   | [1][2<br>] | -           | 30  | 70                       | μΑ   |
|                      |                           | with internal oscillator running   | <u>[1]</u> | -           | 30  | 70                       | μΑ   |
| Logic                |                           |  |            |             |     |                          |      |
| VI                   | input voltage             | on pins SDA, SDAACK and SCL  |            | -0.5        | -   | 5.5                      | V    |
|                      |                           | all other input pins   |            | -0.5        | -   | $(V_{DD} + 0.5) \le 5.5$ | V    |
| $V_{IH}$             | HIGH-level input voltage  | on pins CLK, SYNC, OSC, A0, A1, SA0, SCL and SDA                               |            | $0.7V_{DD}$ | -   | -                        | V    |
| $V_{IL}$             | LOW-level input voltage   | on pins CLK, SYNC, OSC, A0, A1, SA0, SCL and SDA                               |            | -           | -   | $0.3V_{DD}$              | V    |
| Vo                   | output voltage            | on pins SCL and SYNC   |            | -0.5        | -   | $(V_{DD} + 0.5) \le 5.5$ | V    |
|                      |                           | pin SDAACK   |            | -0.5        | -   | 5.5                      | V    |
| I <sub>OH</sub>      | HIGH-level output current | $V_{OH}$ = 4.6 V; $V_{DD}$ = 5 V; on pin CLK                                   |            | 1.5         | -   | -                        | mA   |
| I <sub>OL</sub>      | LOW-level output current  | $V_{OL} = 0.4 \text{ V}; V_{DD} = 5 \text{ V};$                                |            |             |     |                          |      |
|                      |                           | on pins CLK and SYNC   |            | -           | -   | -1.5                     | mΑ   |
|                      |                           | on pin SDAACK  |            | -           | -   | -3                       | mΑ   |
| $V_{POR}$            | power-on reset voltage    |  |            | 1.0         | 1.3 | 1.6                      | V    |
| lL                   | leakage current           | $V_I = V_{DD}$ or $V_{SS}$ ; on pin OSC, CLK, A0, A1, SA0, SDA, SDAACK and SCL |            | -1          | -   | +1                       | μΑ   |
| LCD out              | puts                      |  |            |             |     |                          |      |
| $\Delta V_{O}$       | output voltage variation  | on pins BP0 to BP3 and S0 to S159  | [3][4<br>] | -30         | -   | +30                      | mV   |
| R <sub>O</sub>       | output resistance         | $V_{LCD}$ = 5 V; on pins BP0 to BP3  |            | -           | 1.5 | 5                        | kΩ   |
|                      |                           | $V_{LCD} = 5 \text{ V}$ ; on pins S0 to S159                                   |            | -           | 2.0 | 5                        | kΩ   |

<sup>[1]</sup> LCD outputs are open-circuit; inputs at  $V_{SS}$  or  $V_{DD}$ ;  $I^2C$ -bus inactive;  $V_{LCD}$  = 8.0 V,  $V_{DD}$  = 5.0 V and RAM written with all logic 1.

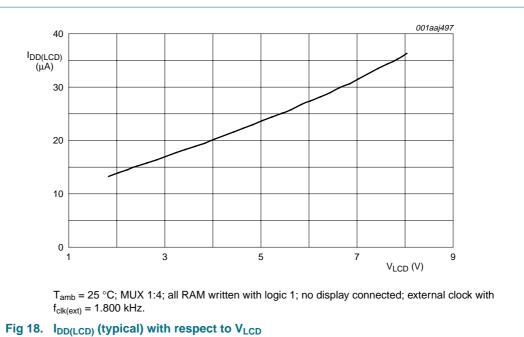
<sup>[2]</sup> External clock with 50 % duty factor.

<sup>[3]</sup> Variation between any 2 backplanes on a given voltage level; static measured.

<sup>[4]</sup> Variation between any 2 segments on a given voltage level; static measured.

**PCF8532 NXP Semiconductors** 

# Universal LCD driver for low multiplex rates



## Universal LCD driver for low multiplex rates

# 11. Dynamic characteristics

Table 18. Dynamic characteristics

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 8.0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified.

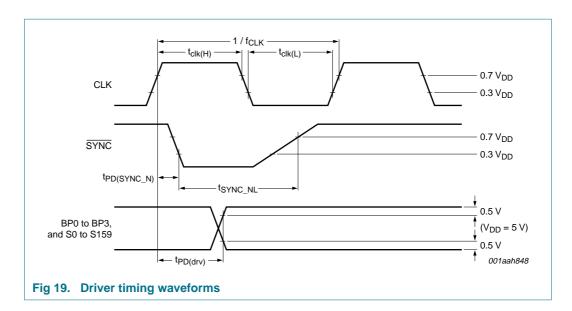
| Symbol                  | Parameter  | Conditions                      |            | Min | Тур  | Max  | Unit |
|-------------------------|--|---------------------------------|------------|-----|------|------|------|
| f <sub>clk</sub>        | clock frequency                                  | on pin CLK; see <u>Table 15</u> | <u>[1]</u> | 900 | 1800 | 3000 | Hz   |
| f <sub>clk(ext)</sub>   | external clock frequency                         |                                 | [2]        | 700 | -    | 5000 | Hz   |
| t <sub>clk(H)</sub>     | HIGH-level clock time                            | external clock source used      |            | 100 | -    | -    | μs   |
| t <sub>clk(L)</sub>     | LOW-level clock time                             | external clock source used      |            | 100 | -    | -    | μs   |
| t <sub>PD(SYNC_N)</sub> | SYNC propagation delay                           |                                 |            | -   | 30   | -    | ns   |
| t <sub>SYNC_NL</sub>    | SYNC LOW time                                    |                                 |            | 100 | -    | -    | μs   |
| $t_{PD(drv)}$           | driver propagation delay                         | $V_{LCD} = 5 V$                 |            | -   | 10   | -    | μs   |
| Timing chara            | cteristics: I <sup>2</sup> C-bus                 |                                 | <u>[3]</u> |     |      |      |      |
| f <sub>SCL</sub>        | SCL clock frequency                              |                                 |            | -   | -    | 400  | kHz  |
| t <sub>BUF</sub>        | bus free time between a STOP and START condition |                                 |            | 1.3 | -    | -    | μs   |
| t <sub>HD;STA</sub>     | hold time (repeated) START condition             |                                 |            | 0.6 | -    | -    | μs   |
| t <sub>SU;STA</sub>     | set-up time for a repeated START condition       |                                 |            | 0.6 | -    | -    | μs   |
| t <sub>VD;ACK</sub>     | data valid acknowledge time                      |                                 |            | -   | -    | 1.2  | μs   |
| t <sub>HIGH</sub>       | HIGH period of the SCL clock                     |                                 |            | 0.6 | -    | -    | μs   |
| $t_{LOW}$               | LOW period of the SCL clock                      |                                 |            | 1.3 | -    | -    | μs   |
| t <sub>f</sub>          | fall time  | of both SDA and SCL signals     |            | -   | -    | 0.3  | μs   |
| t <sub>r</sub>          | rise time  | of both SDA and SCL signals     |            | -   | -    | 0.3  | μs   |
| C <sub>b</sub>          | capacitive load for each bus line                |                                 |            | -   | -    | 400  | pF   |
| t <sub>SU;DAT</sub>     | data set-up time                                 |                                 |            | 200 | -    | -    | ns   |
| t <sub>HD;DAT</sub>     | data hold time                                   |                                 |            | 0   | -    | -    | ns   |
| t <sub>SU;STO</sub>     | set-up time for STOP condition                   |                                 |            | 0.6 | -    | -    | μs   |
| t <sub>w(spike)</sub>   | spike pulse width                                |                                 |            | -   | -    | 50   | ns   |

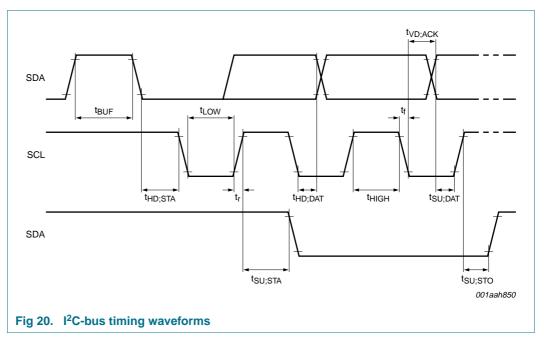
<sup>[1]</sup> Typical output duty factor: 50 % measured at the CLK output pin.

<sup>[2]</sup> For  $f_{clk(ext)} > 4$  kHz it is recommended to use an external pull-up resistor between pin  $\overline{SYNC}$  and pin  $V_{DD}$ . The value of the resistor should be between 100 k $\Omega$  and 1 M $\Omega$ . This resistor should be present even when no cascading configuration is used!

<sup>[3]</sup> All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

# Universal LCD driver for low multiplex rates





Universal LCD driver for low multiplex rates

# 12. Application information

### 12.1 Cascaded operation

In large display configurations, up to 8 PCF8532's can be distinguished on the same I<sup>2</sup>C-bus by using the 2-bit hardware subaddress (A0 and A1) and the programmable I<sup>2</sup>C-bus slave address (SA0). When cascaded PCF8532's are synchronized, they can share the backplane signals from one of the devices in the cascade. Such an arrangement is cost-effective in large LCD applications since the backplane outputs of only one device need to be through-plated to the backplane electrodes of the display. The other PCF8532's of the cascade contribute additional segment outputs but their backplane outputs are left open-circuit (see Figure 21).

For display sizes that are not multiple of 640 elements, a mixed cascaded system can be considered containing only devices like PCF8532 and PCF8533. Depending on the application, one must take care of the software commands compatibility and pin connection compatibility.

The \$\overline{\text{SYNC}}\$ line is provided to maintain the correct synchronization between all cascaded PCF8532's. This synchronization is guaranteed after the power-on reset. The only time that \$\overline{\text{SYNC}}\$ is likely to be needed is if synchronization is accidentally lost (e.g. by noise in adverse electrical environments, or by the definition of a multiplex mode when PCF8532's with different SA0 levels are cascaded). \$\overline{\text{SYNC}}\$ is organized as an input/output pin; the output selection being realized as an open-drain driver with an internal pull-up resistor. A PCF8532 asserts the \$\overline{\text{SYNC}}\$ line at the onset of its last active backplane signal and monitors the \$\overline{\text{SYNC}}\$ line at all other times. Should synchronization in the cascade be lost, it will be restored by the first PCF8532 to assert \$\overline{\text{SYNC}}\$. The timing relationship between the backplane waveforms and the \$\overline{\text{SYNC}}\$ signal for the various drive modes of the PCF8532 are shown in Figure 23.

When using an external clock signal with high frequencies ( $f_{clk(ext)} > 4$  kHz) it is recommended to have an external pull-up resistor between pin SYNC and pin  $V_{DD}$  (see Table 18). This resistor should be present even when no cascading configuration is used! When using it in a cascaded configuration, care must be taken not to route the  $\overline{SYNC}$  signal to close to noisy signals.

The contact resistance between the \$\overline{SYNC}\$ pads of cascaded devices must be controlled. If the resistance is too high, the device will not be able to synchronize properly. This is particularly applicable to COG applications. <a href="Table 19">Table 19</a> shows the limiting values for contact resistance.

In the cascaded applications, the OSC pin of the PCF8532 with subaddress 0 is connected to  $V_{SS}$  so that this device uses its internal clock to generate a clock signal at the CLK pin. The other PCF8532 devices are having the OSC pin connected to  $V_{DD}$ , meaning that this devices are ready to receive external clock, the signal being provided by the device with subaddress 0.

In the case that the master is providing the clock signal to the slave devices, care must be taken that the sending of display enable or disable will be received by both, the master and the slaves at the same time. When the display is disabled the output from pin CLK is disabled too. The disconnection of the clock may result in a DC component for the display.

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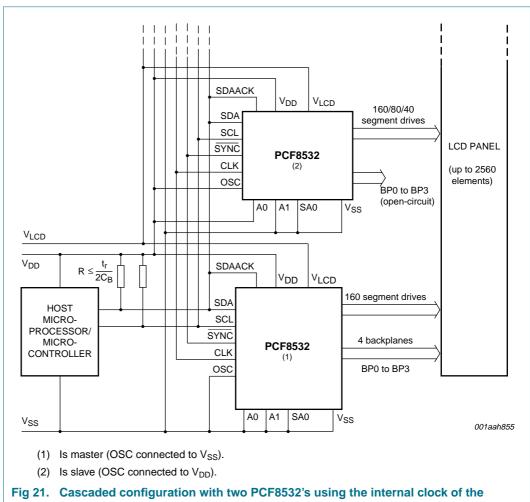
#### Universal LCD driver for low multiplex rates

Alternatively the schematic can be also constructed such that all the devices have OSC pin connected to V<sub>DD</sub> and thus an external CLK being provided for the system (all devices connected to the same external CLK).

A configuration where SYNC is connected but all PCF8532 are using the internal clock (OSC pin tied to V<sub>SS</sub>) is not recommended and may lead to display artefacts!

Table 19. SYNC contact resistance

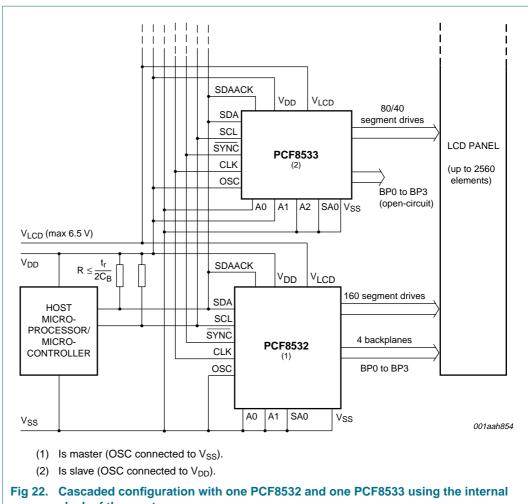
| Number of devices | Maximum contact resistance |
|-------------------|----------------------------|
| 2                 | 6000 Ω                     |
| 3 to 5            | 2200 Ω                     |
| 6 to 8            | 1200 Ω                     |



master

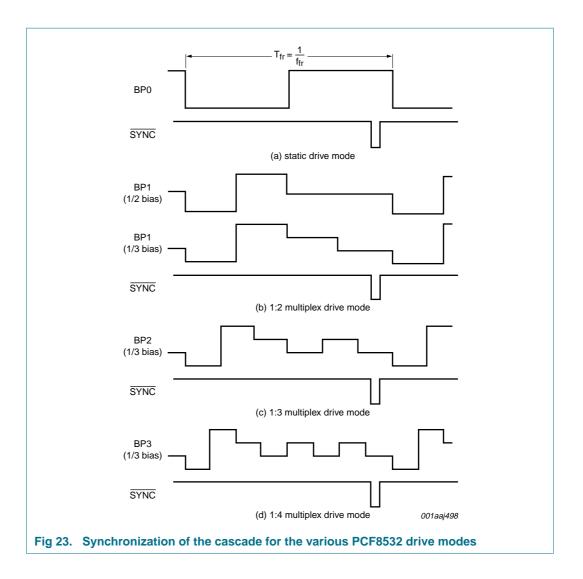
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clock of the master

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# 13. Bare die outline

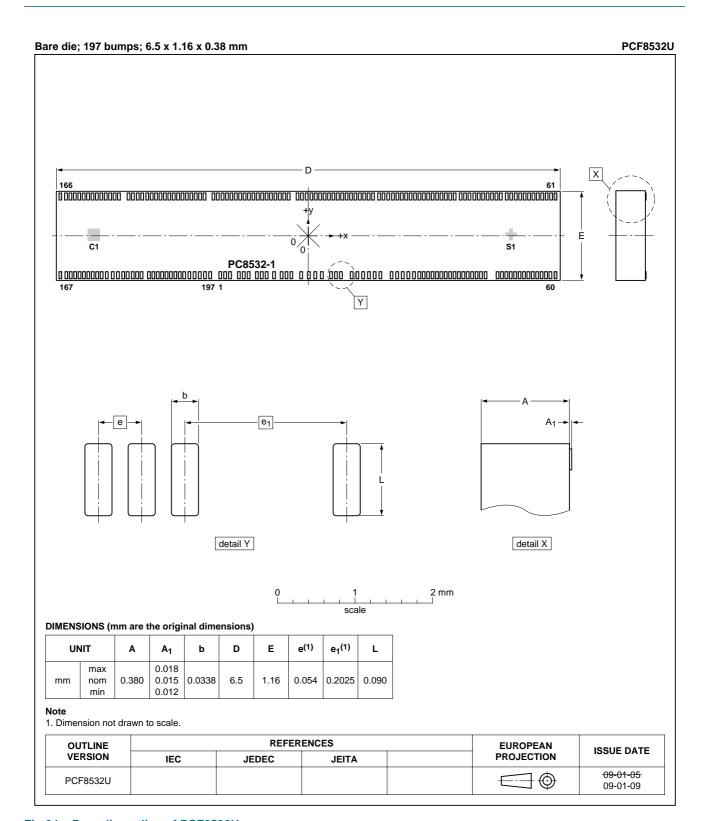


Fig 24. Bare die outline of PCF8532U

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# Universal LCD driver for low multiplex rates

Table 20. Pin locations

| Symbol    | Pad | <b>Χ (μm)</b> | <b>Υ (μm)</b>     | Symbol | Pad | <b>Χ (μm)</b> | <b>Υ (μm)</b> |
|-----------|-----|---------------|-------------------|--------|-----|---------------|---------------|
| SDAACK    | 1   | -1165.3       | <del>-481.5</del> | S68    | 100 | 750.2         | 481.5         |
| SDAACK    | 2   | -1111.3       | -481.5            | S69    | 101 | 696.2         | 481.5         |
| SDAACK    | 3   | -1057.3       | <del>-481.5</del> | S70    | 102 | 642.2         | 481.5         |
| SDA       | 4   | -854.8        | -481.5            | S71    | 103 | 588.2         | 481.5         |
| SDA       | 5   | -800.8        | -481.5            | S72    | 104 | 534.2         | 481.5         |
| SDA       | 6   | -746.8        | -481.5            | S73    | 105 | 480.2         | 481.5         |
| SCL       | 7   | -575.8        | -481.5            | S74    | 106 | 426.2         | 481.5         |
| SCL       | 8   | -521.8        | -481.5            | S75    | 107 | 372.2         | 481.5         |
| SCL       | 9   | -467.8        | -481.5            | S76    | 108 | 318.2         | 481.5         |
| CLK       | 10  | -316.2        | -481.5            | S77    | 109 | 264.2         | 481.5         |
| $V_{DD}$  | 11  | -204.1        | -481.5            | S78    | 110 | 210.2         | 481.5         |
| $V_{DD}$  | 12  | -150.1        | -481.5            | S79    | 111 | 156.2         | 481.5         |
| $V_{DD}$  | 13  | -96.1         | -481.5            | BP0    | 112 | 86.8          | 481.5         |
| SYNC      | 14  | 6.9           | -481.5            | BP2    | 113 | 32.8          | 481.5         |
| OSC       | 15  | 119.4         | -481.5            | BP1    | 114 | -21.2         | 481.5         |
| T1        | 16  | 203.1         | -481.5            | BP3    | 115 | -75.2         | 481.5         |
| T2        | 17  | 286.8         | -481.5            | S80    | 116 | -190.7        | 481.5         |
| T3        | 18  | 389.9         | -481.5            | S81    | 117 | -244.7        | 481.5         |
| T3        | 19  | 443.9         | -481.5            | S82    | 118 | -298.7        | 481.5         |
| T3        | 20  | 497.9         | -481.5            | S83    | 119 | -352.7        | 481.5         |
| A0        | 21  | 640.5         | -481.5            | S84    | 120 | -406.7        | 481.5         |
| A1        | 22  | 724.2         | -481.5            | S85    | 121 | -460.7        | 481.5         |
| SA0       | 23  | 807.9         | -481.5            | S86    | 122 | -514.7        | 481.5         |
| $V_{SS}$  | 24  | 893.0         | -481.5            | S87    | 123 | -568.7        | 481.5         |
| $V_{SS}$  | 25  | 947.0         | -481.5            | S88    | 124 | -622.7        | 481.5         |
| $V_{SS}$  | 26  | 1001.0        | -481.5            | S89    | 125 | -676.7        | 481.5         |
| $V_{LCD}$ | 27  | 1107.2        | -481.5            | S90    | 126 | -730.7        | 481.5         |
| $V_{LCD}$ | 28  | 1161.2        | -481.5            | S91    | 127 | -784.7        | 481.5         |
| $V_{LCD}$ | 29  | 1215.2        | -481.5            | S92    | 128 | -838.7        | 481.5         |
| BP2       | 30  | 1303.4        | -481.5            | S93    | 129 | -892.7        | 481.5         |
| BP0       | 31  | 1357.4        | -481.5            | S94    | 130 | -946.7        | 481.5         |
| S0        | 32  | 1411.4        | -481.5            | S95    | 131 | -1000.7       | 481.5         |
| S1        | 33  | 1465.4        | -481.5            | S96    | 132 | -1054.7       | 481.5         |
| S2        | 34  | 1519.4        | -481.5            | S97    | 133 | -1108.7       | 481.5         |
| S3        | 35  | 1573.4        | -481.5            | S98    | 134 | -1224.2       | 481.5         |
| S4        | 36  | 1627.4        | -481.5            | S99    | 135 | -1278.2       | 481.5         |
| S5        | 37  | 1681.4        | -481.5            | S100   | 136 | -1332.2       | 481.5         |
| S6        | 38  | 1735.4        | -481.5            | S101   | 137 | -1386.2       | 481.5         |
| S7        | 39  | 1789.4        | -481.5            | S102   | 138 | -1440.2       | 481.5         |
| S8        | 40  | 1843.4        | -481.5            | S103   | 139 | -1494.2       | 481.5         |
| S9        | 41  | 1897.4        | -481.5            | S104   | 140 | -1548.2       | 481.5         |

# Universal LCD driver for low multiplex rates

Table 20. Pin locations

| Symbol | Pad | <b>Χ (μm)</b> | <b>Υ (μm)</b> | Symbol | Pad | <b>Χ (μm)</b> | <b>Υ (μm)</b>     |
|--------|-----|---------------|---------------|--------|-----|---------------|-------------------|
| S10    | 42  | 1951.4        | -481.5        | S105   | 141 | -1602.2       | 481.5             |
| S11    | 43  | 2005.4        | -481.5        | S106   | 142 | -1656.2       | 481.5             |
| S12    | 44  | 2059.4        | -481.5        | S107   | 143 | -1710.2       | 481.5             |
| S13    | 45  | 2113.4        | -481.5        | S108   | 144 | -1764.2       | 481.5             |
| S14    | 46  | 2167.4        | -481.5        | S109   | 145 | -1818.2       | 481.5             |
| S15    | 47  | 2221.4        | -481.5        | S110   | 146 | -1872.2       | 481.5             |
| S16    | 48  | 2363.9        | -481.5        | S111   | 147 | -1926.2       | 481.5             |
| S17    | 49  | 2417.9        | -481.5        | S112   | 148 | -1980.2       | 481.5             |
| S18    | 50  | 2471.9        | -481.5        | S113   | 149 | -2034.2       | 481.5             |
| S19    | 51  | 2525.9        | -481.5        | S114   | 150 | -2088.2       | 481.5             |
| S20    | 52  | 2579.9        | -481.5        | S115   | 151 | -2142.2       | 481.5             |
| S21    | 53  | 2633.9        | -481.5        | S116   | 152 | -2284.7       | 481.5             |
| S22    | 54  | 2687.9        | -481.5        | S117   | 153 | -2338.7       | 481.5             |
| S23    | 55  | 2741.9        | -481.5        | S118   | 154 | -2392.7       | 481.5             |
| S24    | 56  | 2795.9        | -481.5        | S119   | 155 | -2446.7       | 481.5             |
| S25    | 57  | 2849.9        | -481.5        | S120   | 156 | -2500.7       | 481.5             |
| S26    | 58  | 2903.9        | -481.5        | S121   | 157 | -2554.7       | 481.5             |
| S27    | 59  | 2957.9        | -481.5        | S122   | 158 | -2608.7       | 481.5             |
| S28    | 60  | 3011.9        | -481.5        | S123   | 159 | -2662.7       | 481.5             |
| S29    | 61  | 3067.7        | 481.5         | S124   | 160 | -2716.7       | 481.5             |
| S30    | 62  | 3013.7        | 481.5         | S125   | 161 | -2770.7       | 481.5             |
| S31    | 63  | 2959.7        | 481.5         | S126   | 162 | -2824.7       | 481.5             |
| S32    | 64  | 2905.7        | 481.5         | S127   | 163 | -2878.7       | 481.5             |
| S33    | 65  | 2851.7        | 481.5         | S128   | 164 | -2932.7       | 481.5             |
| S34    | 66  | 2797.7        | 481.5         | S129   | 165 | -2986.7       | 481.5             |
| S35    | 67  | 2743.7        | 481.5         | S130   | 166 | -3040.7       | 481.5             |
| S36    | 68  | 2689.7        | 481.5         | S131   | 167 | -3025.2       | -481.5            |
| S37    | 69  | 2635.7        | 481.5         | S132   | 168 | -2971.2       | -481.5            |
| S38    | 70  | 2520.2        | 481.5         | S133   | 169 | -2917.2       | -481.5            |
| S39    | 71  | 2466.2        | 481.5         | S134   | 170 | -2863.2       | <del>-481.5</del> |
| S40    | 72  | 2412.2        | 481.5         | S135   | 171 | -2809.2       | -481.5            |
| S41    | 73  | 2358.2        | 481.5         | S136   | 172 | -2755.2       | <del>-481.5</del> |
| S42    | 74  | 2304.2        | 481.5         | S137   | 173 | -2701.2       | -481.5            |
| S43    | 75  | 2250.2        | 481.5         | S138   | 174 | -2647.2       | <del>-481.5</del> |
| S44    | 76  | 2196.2        | 481.5         | S139   | 175 | -2593.2       | <del>-481.5</del> |
| S45    | 77  | 2142.2        | 481.5         | S140   | 176 | -2539.2       | <del>-481.5</del> |
| S46    | 78  | 2088.2        | 481.5         | S141   | 177 | -2485.2       | <del>-481.5</del> |
| S47    | 79  | 2034.2        | 481.5         | S142   | 178 | -2431.2       | <del>-481.5</del> |
| S48    | 80  | 1891.7        | 481.5         | S143   | 179 | -2377.2       | <del>-481.5</del> |
| S49    | 81  | 1837.7        | 481.5         | S144   | 180 | -2234.7       | <del>-481.5</del> |
| S50    | 82  | 1783.7        | 481.5         | S145   | 181 | -2180.7       | <del>-481.5</del> |

**PCF8532 NXP Semiconductors** 

# Universal LCD driver for low multiplex rates

Table 20. Pin locations

| Symbol | Pad | <b>Χ (μm)</b> | <b>Υ (μm)</b> | Symbol | Pad | <b>Χ (μm)</b> | <b>Υ (μm)</b> |
|--------|-----|---------------|---------------|--------|-----|---------------|---------------|
| S51    | 83  | 1729.7        | 481.5         | S146   | 182 | -2126.7       | -481.5        |
| S52    | 84  | 1675.7        | 481.5         | S147   | 183 | -2072.7       | -481.5        |
| S53    | 85  | 1621.7        | 481.5         | S148   | 184 | -2018.7       | -481.5        |
| S54    | 86  | 1567.7        | 481.5         | S149   | 185 | -1964.7       | -481.5        |
| S55    | 87  | 1513.7        | 481.5         | S150   | 186 | -1910.7       | -481.5        |
| S56    | 88  | 1459.7        | 481.5         | S151   | 187 | -1856.7       | -481.5        |
| S57    | 89  | 1405.7        | 481.5         | S152   | 188 | -1802.7       | -481.5        |
| S58    | 90  | 1351.7        | 481.5         | S153   | 189 | -1748.7       | -481.5        |
| S59    | 91  | 1297.7        | 481.5         | S154   | 190 | -1694.7       | -481.5        |
| S60    | 92  | 1243.7        | 481.5         | S155   | 191 | -1640.7       | -481.5        |
| S61    | 93  | 1189.7        | 481.5         | S156   | 192 | -1586.7       | -481.5        |
| S62    | 94  | 1135.7        | 481.5         | S157   | 193 | -1532.7       | -481.5        |
| S63    | 95  | 1081.7        | 481.5         | S158   | 194 | -1478.7       | -481.5        |
| S64    | 96  | 1027.7        | 481.5         | S159   | 195 | -1424.7       | -481.5        |
| S65    | 97  | 973.7         | 481.5         | BP3    | 196 | -1370.7       | -481.5        |
| S66    | 98  | 858.2         | 481.5         | BP1    | 197 | -1316.7       | -481.5        |
| S67    | 99  | 804.2         | 481.5         | -      | -   | -             | -             |

The dummy pads are connected to the segments shown (see Table 21) but are not tested.

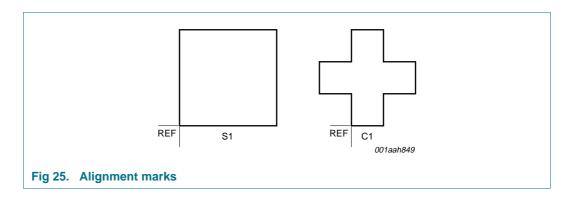
Table 21. Dummy pads

| Symbol | Connected to pin | <b>Χ (μm)</b> | <b>Υ (μm)</b> |
|--------|------------------|---------------|---------------|
| D1     | S131             | -3079.2       | -481.5        |
| D2     | S28              | 3065.9        | -481.5        |
| D3     | S29              | 3121.7        | 481.5         |
| D4     | S130             | -3094.7       | 481.5         |

The alignment marks are shown in Table 22.

Table 22. Alignment marks

| Symbol | Size (μm)            | <b>Χ (μm)</b> | Υ (μm) |
|--------|----------------------|---------------|--------|
| S1     | $121.5 \times 121.5$ | -2733.75      | -47.25 |
| C1     | $121.5 \times 121.5$ | 2603.7        | -47.25 |

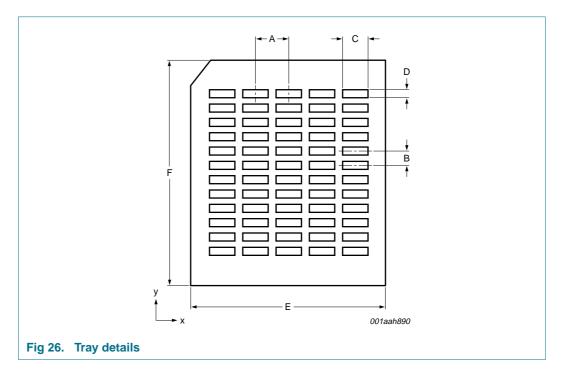


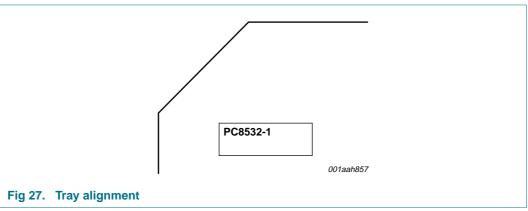
# Universal LCD driver for low multiplex rates

# 14. Packing information

Table 23. Tray dimensions (see Figure 26)

| Symbol | Description                    | Value   |
|--------|--------------------------------|---------|
| A      | pocket pitch in x direction    | 8.8 mm  |
| В      | pocket pitch in y direction    | 3.6 mm  |
| С      | pocket width in x direction    | 6.65 mm |
| D      | pocket width in y direction    | 1.31 mm |
| Е      | tray width in x direction      | 50.8 mm |
| F      | tray width in y direction      | 50.8 mm |
| Х      | number of pockets, x direction | 5       |
| у      | number of pockets, y direction | 12      |





# Universal LCD driver for low multiplex rates

# 15. Abbreviations

Table 24. Abbreviations

| Acronym          | Description                             |
|------------------|---|
| CMOS             | Complementary Metal Oxide Semiconductor |
| COG              | Chip-On-Glass                           |
| НВМ              | Human Body Model                        |
| I <sup>2</sup> C | Inter-Integrated Circuit                |
| ITO              | Indium Tin Oxide                        |
| LCD              | Liquid Crystal Display                  |
| LSB              | Least Significant Bit                   |
| MM               | Machine Model                           |
| MSB              | Most Significant Bit                    |
| RAM              | Random Access Memory                    |
| RMS              | Root Mean Square                        |

# Universal LCD driver for low multiplex rates

# 16. Revision history

# Table 25. Revision history

| Document ID | Release date | Data sheet status  | Change notice | Supersedes |
|-------------|--------------|--------------------|---------------|------------|
| PCF8532_1   | 20090210     | Product data sheet | -             | -          |

#### Universal LCD driver for low multiplex rates

# 17. Legal information

#### 17.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### 18. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

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# Universal LCD driver for low multiplex rates

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